

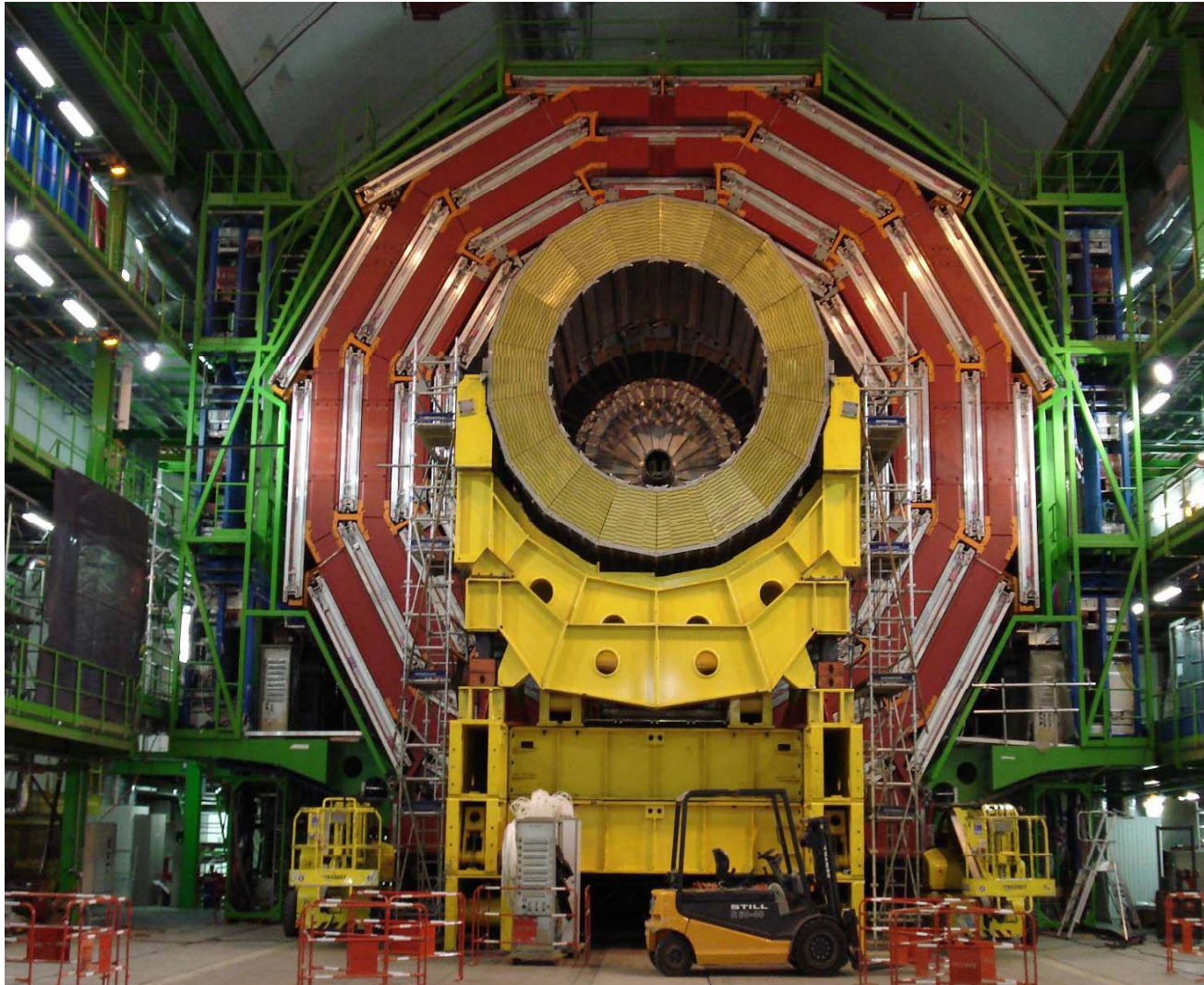
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# CMS Upgrade Plans

Detector upgrade needs  
CMS Upgrade organization



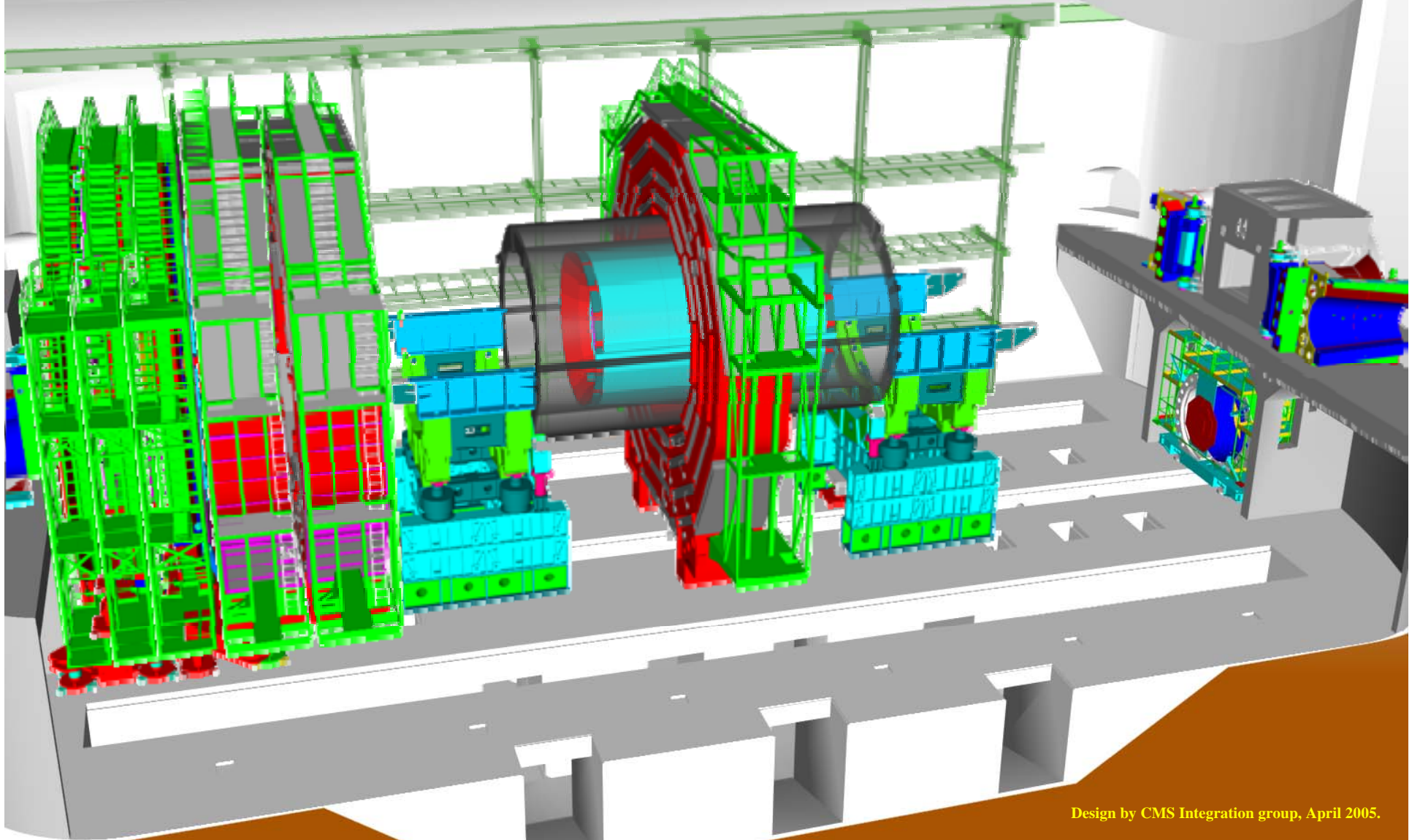
# UXC: -z end fully open. HB+ ready to insert



Haven't quite  
Finished CMS  
Yet...

But planning to  
upgrade the bits  
not yet  
installed!

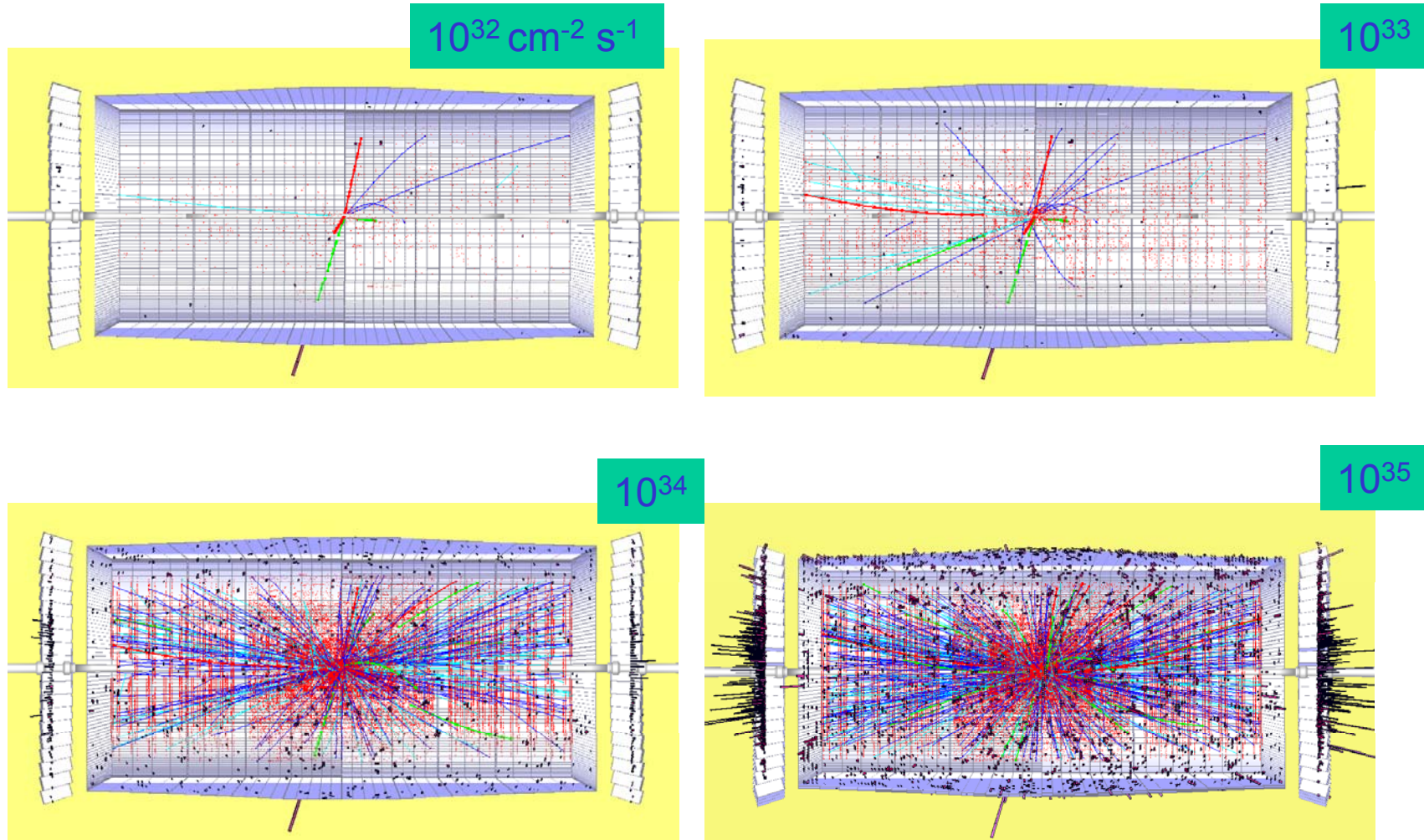
# Current CMS Status: Inserstion of HB+ this week



Design by CMS Integration group, April 2005.



# CMS from LHC to SLHC



The tracker is the key detector which will require upgrading for SLHC

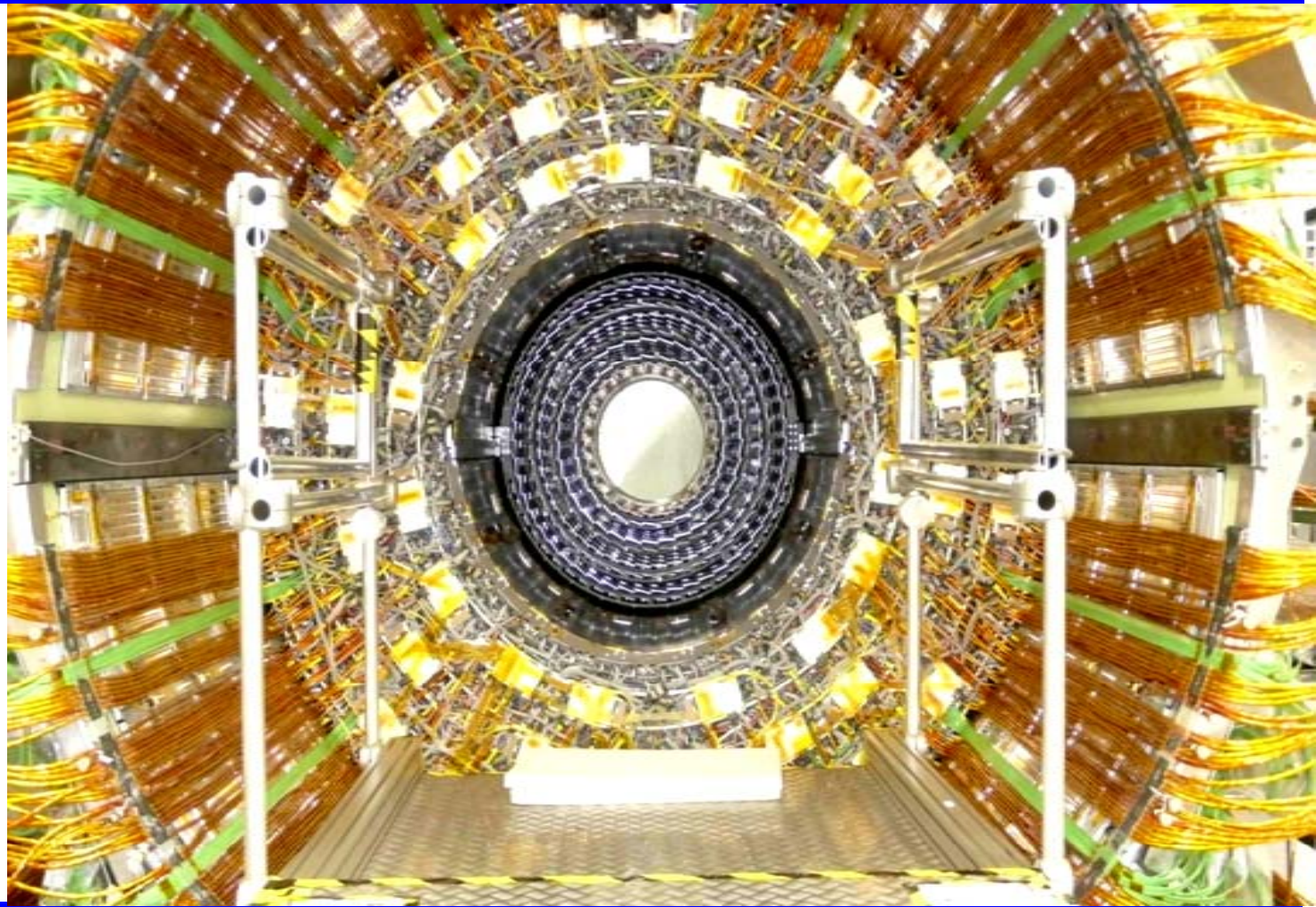
I. Osborne





# CMS Tracking System Up-date - January 07

**TIB+ Inserted  
into TOB+  
Seen from  
the - End**



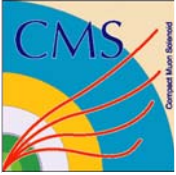




# CMS Tracking System Up-date - February 07

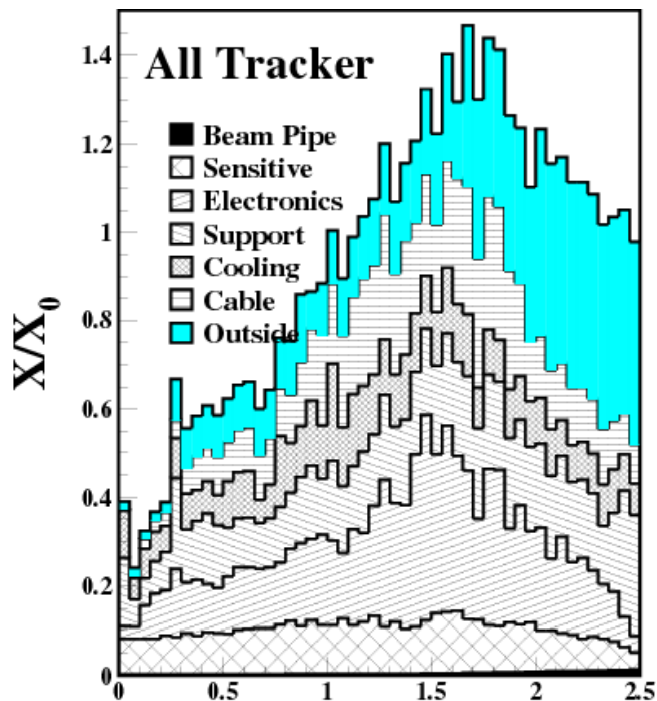
**The Aachen Team  
with TEC +  
End Cover Removed  
to show Silicon**





# Key issues for tracker upgrades

- Power
  - How to get current needed to the electronics
  - More complicated front ends will want more power
    - DC-DC converters, Serial powering
- Material Budget
  - Can we build a better/lighter tracker?



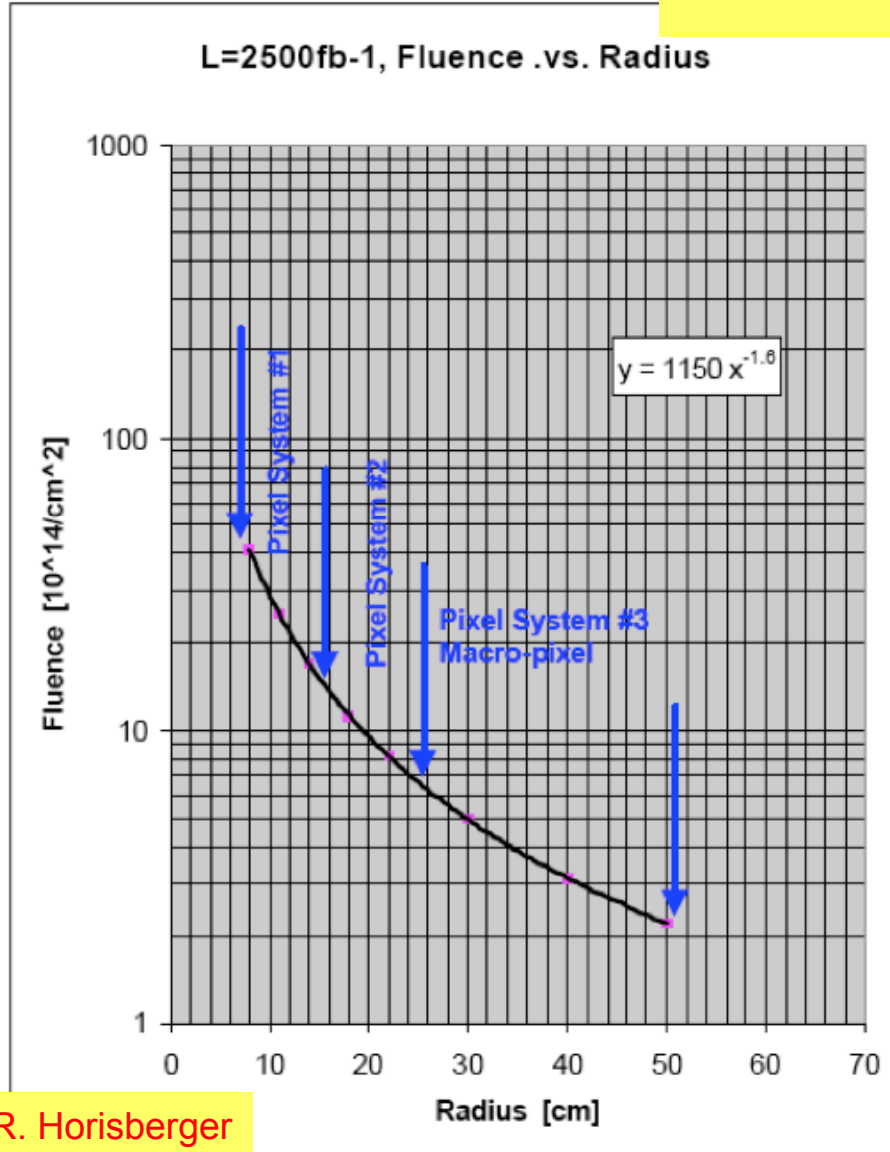
## Tracker R&D focus

- Performance and detector layout
- Sensor material and operation
- Outer tracker readout system definition
- Pixel system and triggering
- Manufacture and material budget



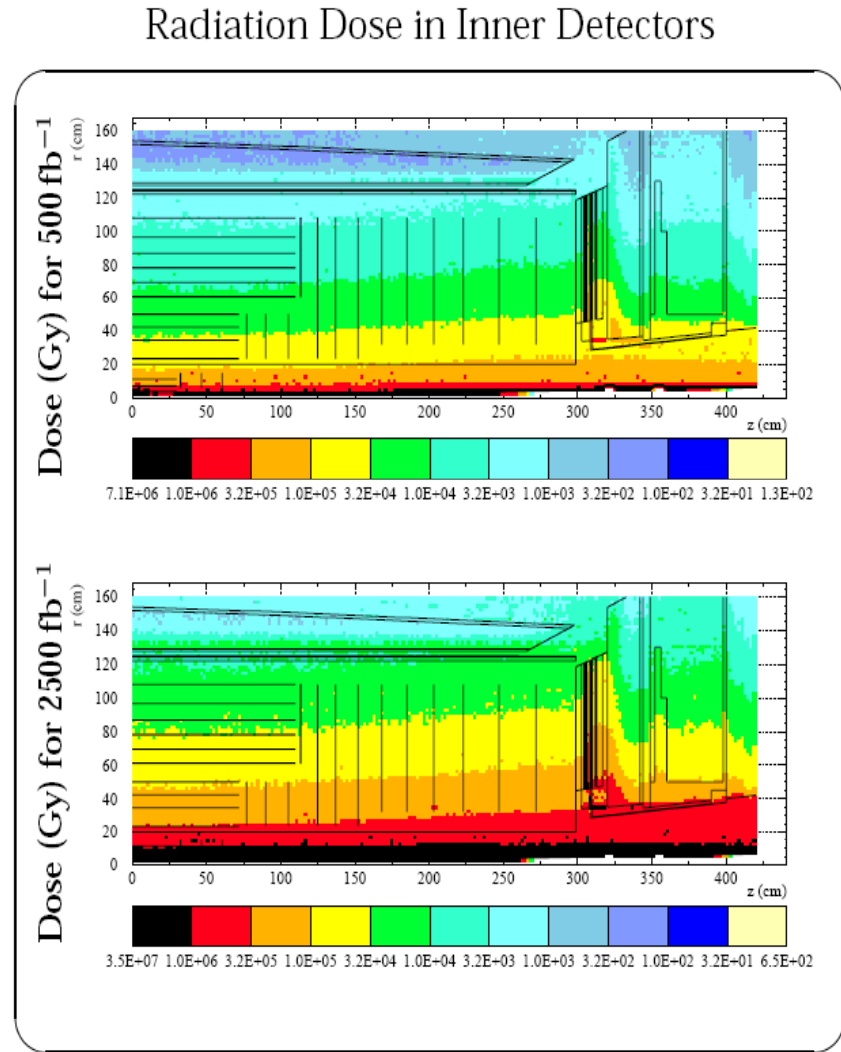
# Radiation environment for trackers

Except for the very innermost layers current technologies should survive SLHC



R. Horisberger

19 March 2007



M. Huhtinen

SLHC Electronics Workshop 26 February 2004

3

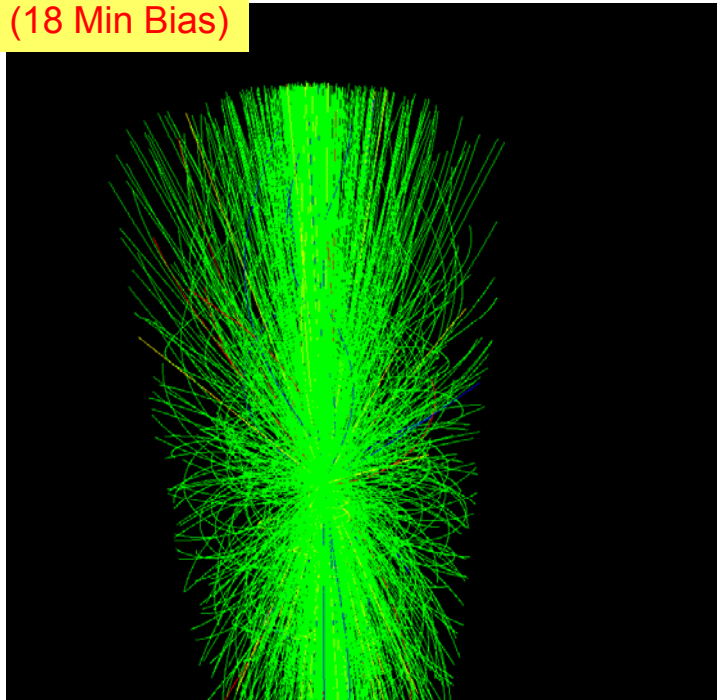
J. Nash - ACES Workshop

8

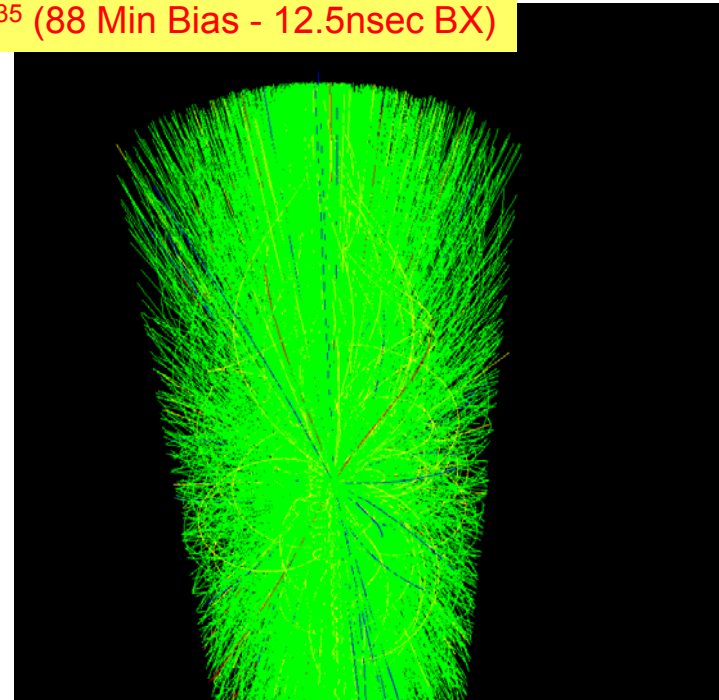


# Tracker occupancy

$10^{34}$  (18 Min Bias)



$10^{35}$  (88 Min Bias - 12.5nsec BX)



Do we want/need an analog or digital readout tracker?

Higher granularity for inner layers needed

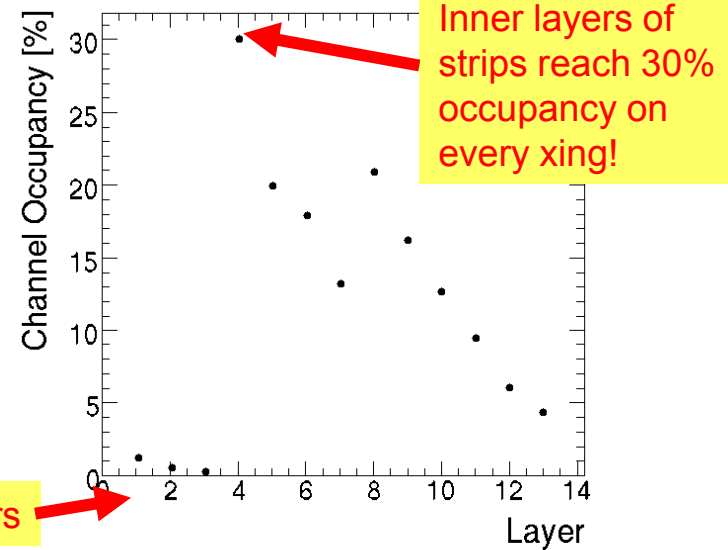
R (cm)	$\langle N_{ch} \rangle / \text{cm}^2 / 12.5\text{ns}$	$\langle N_{ch} \rangle / (1.28\text{cm})^2 / 12.5\text{ns}$
8	2.41	3.94
11	1.47	2.41
14	0.97	1.59

A. Rose



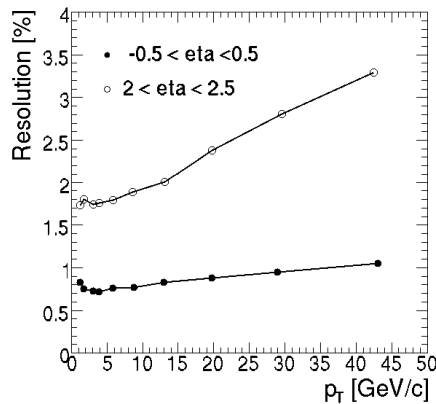
# Tracking with 500 min Bias events

- Study of current CMS tracker for Heavy Ion events
- Track density very similar to 75ns running
  - $dn^{ch}/d\eta/\text{crossing} \approx 3000$
  - Tracker occupancy very high
  - Need more pixel layers
- Tracking possible
  - When tracks are found they are well measured
  - Efficiency and fake rate suffer

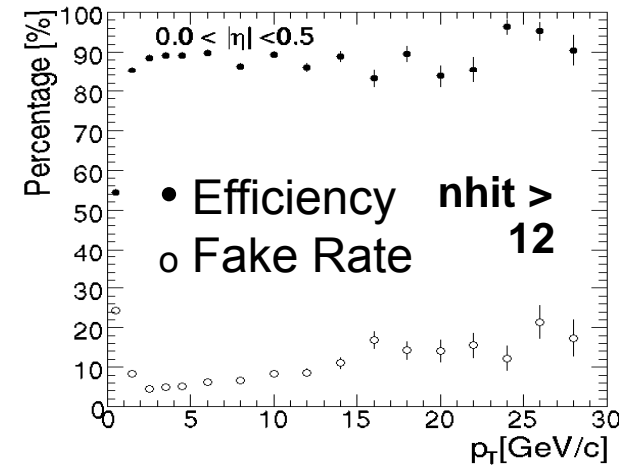
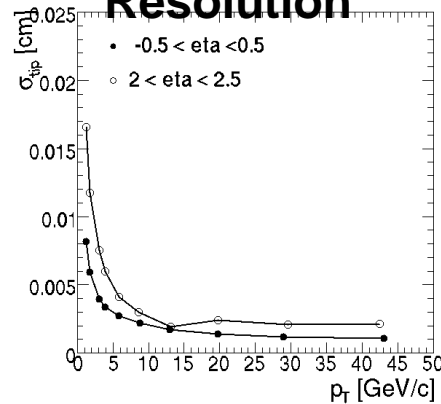


Pixel layers

## Momentum Resolution



## Transverse Impact Parameter Resolution

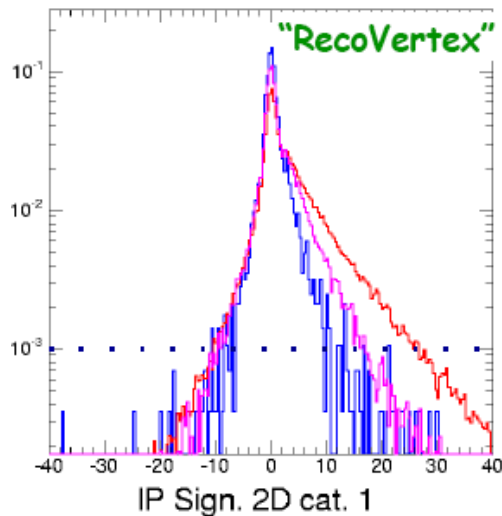
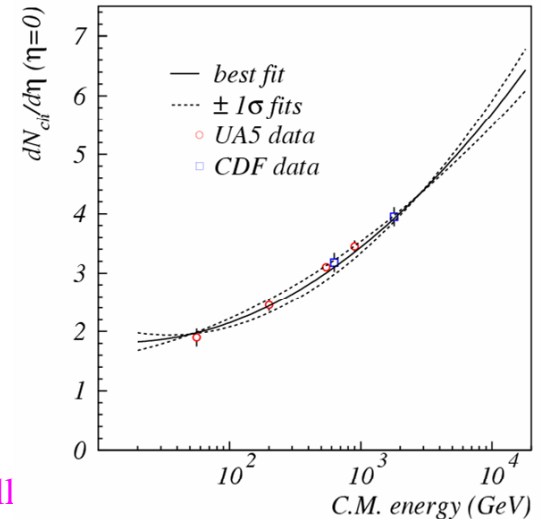


C. Roland



# B-Tagging

- Pile-up overlaps with High Pt event faking a displaced vertex
  - 12.5 ns  $dn^{ch}/d\eta/\text{crossing} \approx 600$  and  $\approx 3000$  tracks in tracker acceptance
  - 75 ns  $dn^{ch}/d\eta/\text{crossing} \approx 3000$  and  $\approx 15000$  tracks in tracker acceptance
- B-tag performance depends on
  - Vertex resolution
  - Luminosity/bunch crossing
  - Size of luminous region (how far apart are the min-bias events)
- For 75ns option expect 2-3 min-bias events within  $200 \mu\text{m}$  of any interesting event.
  - Need simulation to understand how much this reduces b-tagging efficiency
  - All this pushes for larger area of Pixel coverage, need to look at pixel size as well

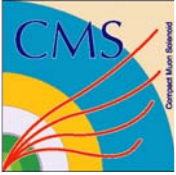


**Exploit (weak) decay and production properties of b-hadrons:**

- Lifetime of about 1.5 ps  $\rightarrow$  secondary (tertiary) decay vertex; displaced tracks
- High mass and decay multiplicity
- Hard b-quark fragmentation function
- Decay kinematics (e.g. rapidities)
- Semi-leptonic decays

C.Weiser    A Combined SV Based B-Tagging Algorithm in CMS    CMS Phys. Meeting 6/12/2005    P 3

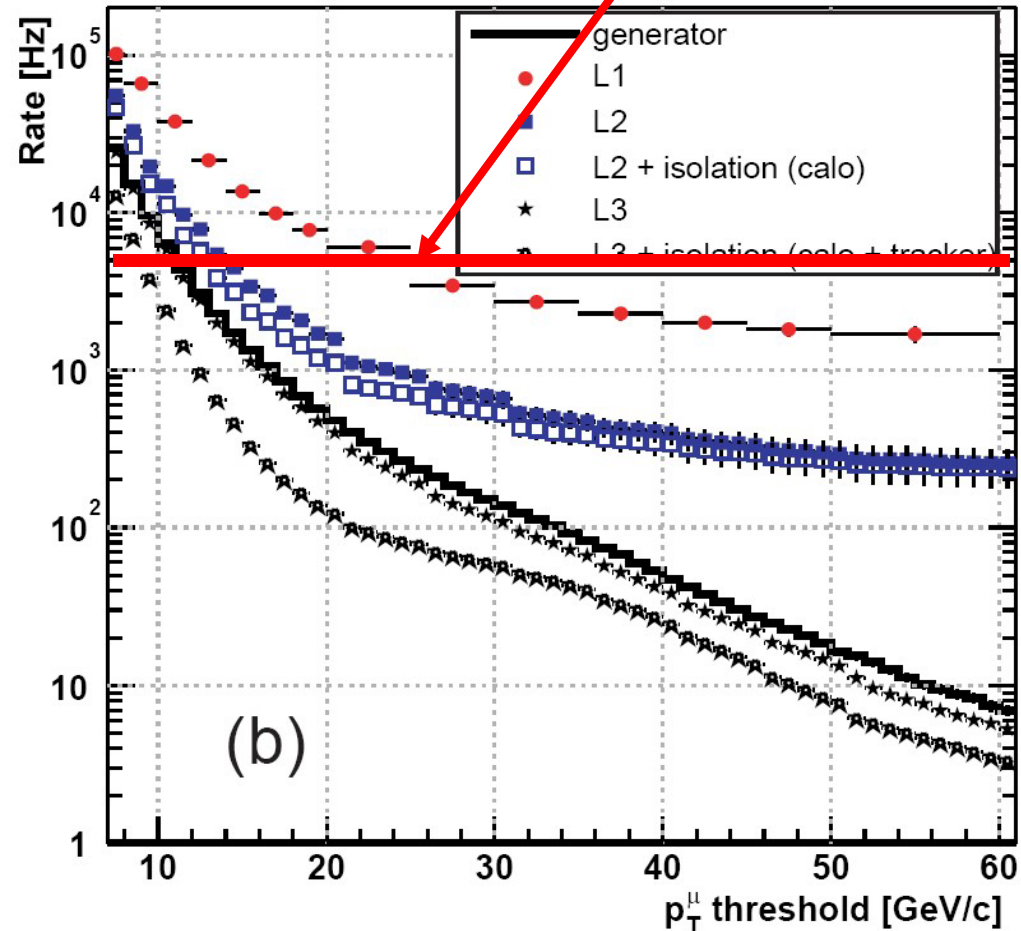


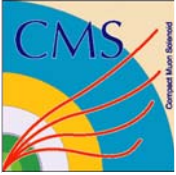


# Level 1 Trigger

Level 1 Trigger has no discrimination for  $P_T > \sim 20$  GeV/c

- The trigger/daq system of CMS will require an upgrade to cope with the higher occupancies and data rates at SLHC
- One of the key issues for CMS is the requirement to include some element of tracking in the Level 1 Trigger
  - There may not be enough rejection power using the muon and calorimeter triggers to handle the higher luminosity conditions at SLHC
  - Adding tracking information at Level 1 gives the ability to adjust  $P_T$  thresholds



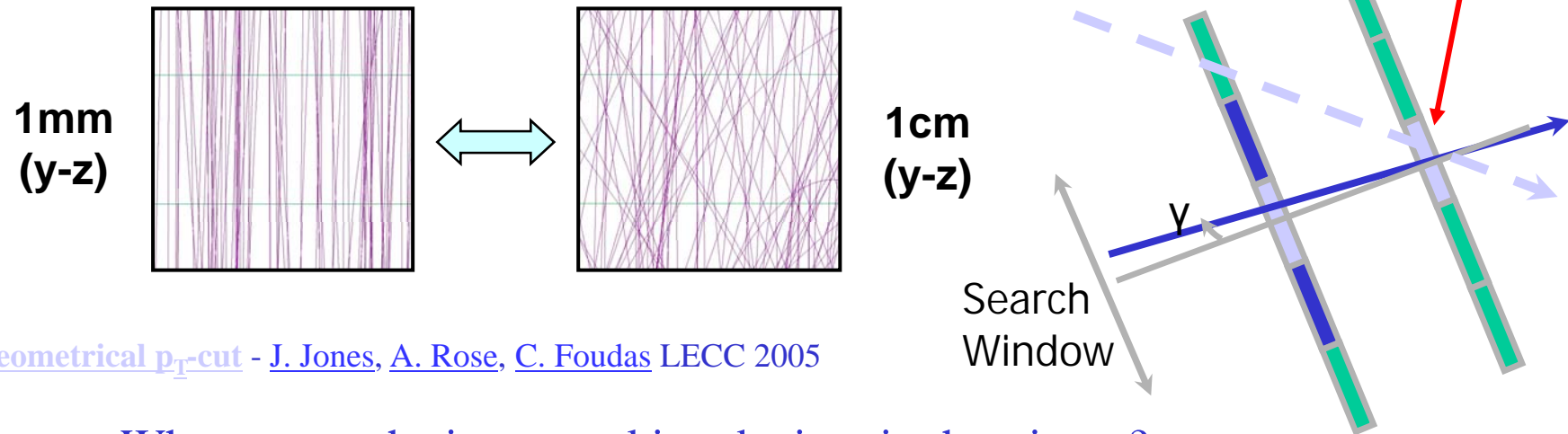


# Trigger/DAQ Parameters

- Level 1 Trigger rate to stay at maximum of 100 kHz
  - Raise  $p_T$  thresholds to reduce rates
- Latency - doubled to 256 BX (6.4  $\mu$ sec)
  - Extra time needed for more complex algorithms
    - Correlating with tracker information at Level 1
  - ECAL is the limit
    - Don't plan to replace the front end electronics
  - New trackers would have to respect this limit
    - Can't keep TOB as is
    - Smaller feature sizes may help
- DAQ system needs to be re-designed with increased bandwidth to handle 10 times the data volume

# Tracking Trigger?

High momentum tracks are straighter so pixels line up



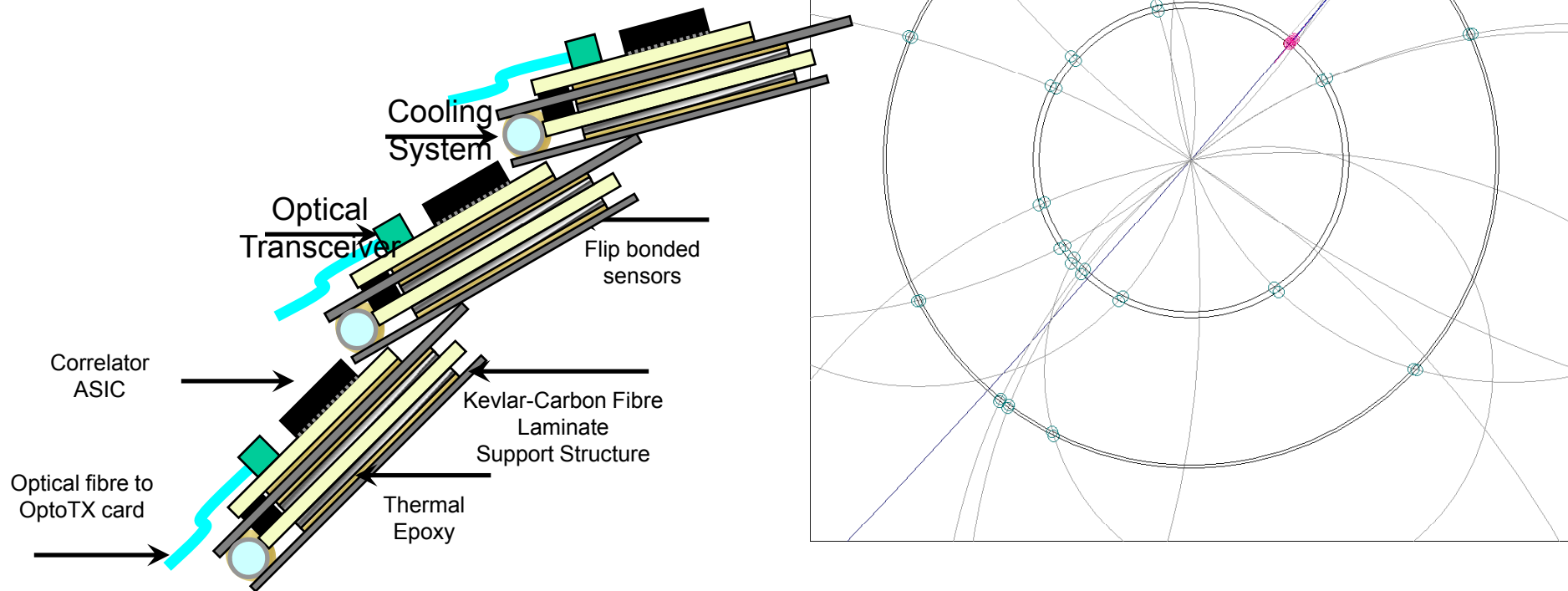
Geometrical  $p_T$ -cut - [J. Jones](#), [A. Rose](#), [C. Foudas](#) LECC 2005

- Why not use the inner tracking devices in the trigger?
  - Number of hits in tracking devices on each trigger is enormous
  - Impossible to get all the data out in order to form a trigger inside
  - How to correlate information internally in order to form segments?
- Possible topic requiring substantial R&D
  - “Stacked” pixels which can measure  $p_T$  of track segments locally
    - Two layers about 1mm apart that could communicate



# Implementing stacked layers

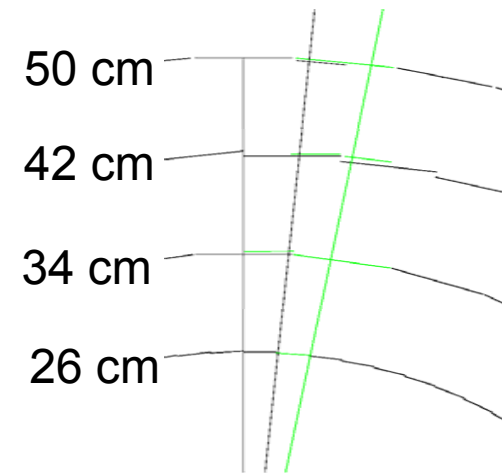
- Single stacked layer gives a Pt cut
- Two stacked layers give a Pt measurement





# Other ideas for Level 1 input

- Alternative idea (F. Palla) pattern recognition in sectors (ala CDF)
- Pixel System for radii at 34, 42, 50 cm
  - Silicon strips (actual) have sensor element area of 10 to 15 mm<sup>2</sup>
  - 10 fold increase in the luminosity would need a 10 fold decrease of it
    - Large elongated pixels of 200 μm x 5 mm
    - Sensor area 6 (r-φ) x 12 (z) cm<sup>2</sup>
    - 3 - 4 fibers/module for 5 Gbps



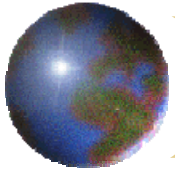
Layer No.	Radius (cm)	Hit/module/b x <sup>a</sup>	No. detectors in φ	Hits/sector/b x <sup>a</sup>	Data rate*/module (Gbps)	Data rate*/sector (Gbps)	No. data links†/layer
1	26	3.1	82	43	5	69	1100
2	34	8.7	36	78	14	125	900
3	42	5.8	44	49	8	78	700
4	50	3.7	52	34	6	55	600



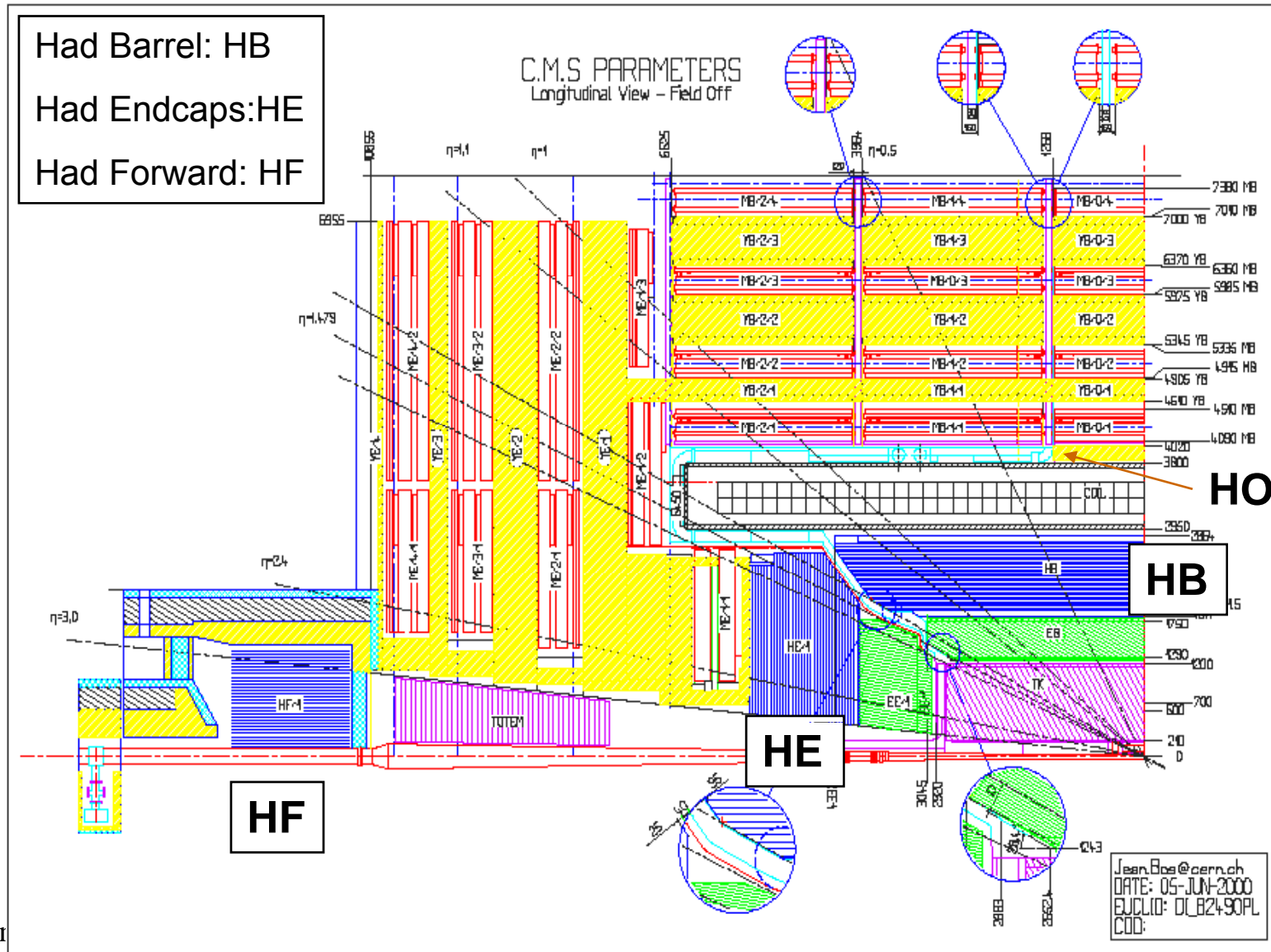
# Calorimeters

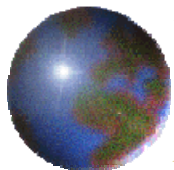
- ECAL
  - Barrel and endcap crystals and electronics designed to operate in SLHC conditions
  - Electronics for barrel is not accessible without disassembly of the barrel
  - Electronics on the Endcap could be accessed in principle, but the activation may make this difficult
- HCAL
  - Scintillator may suffer damage for  $\eta > 2$ 
    - R & D required
    - Finer granularity
  - HF some very high  $\eta$  towers lost
    - HF and shielding system issues with new insertion
      - Potential large additional cost



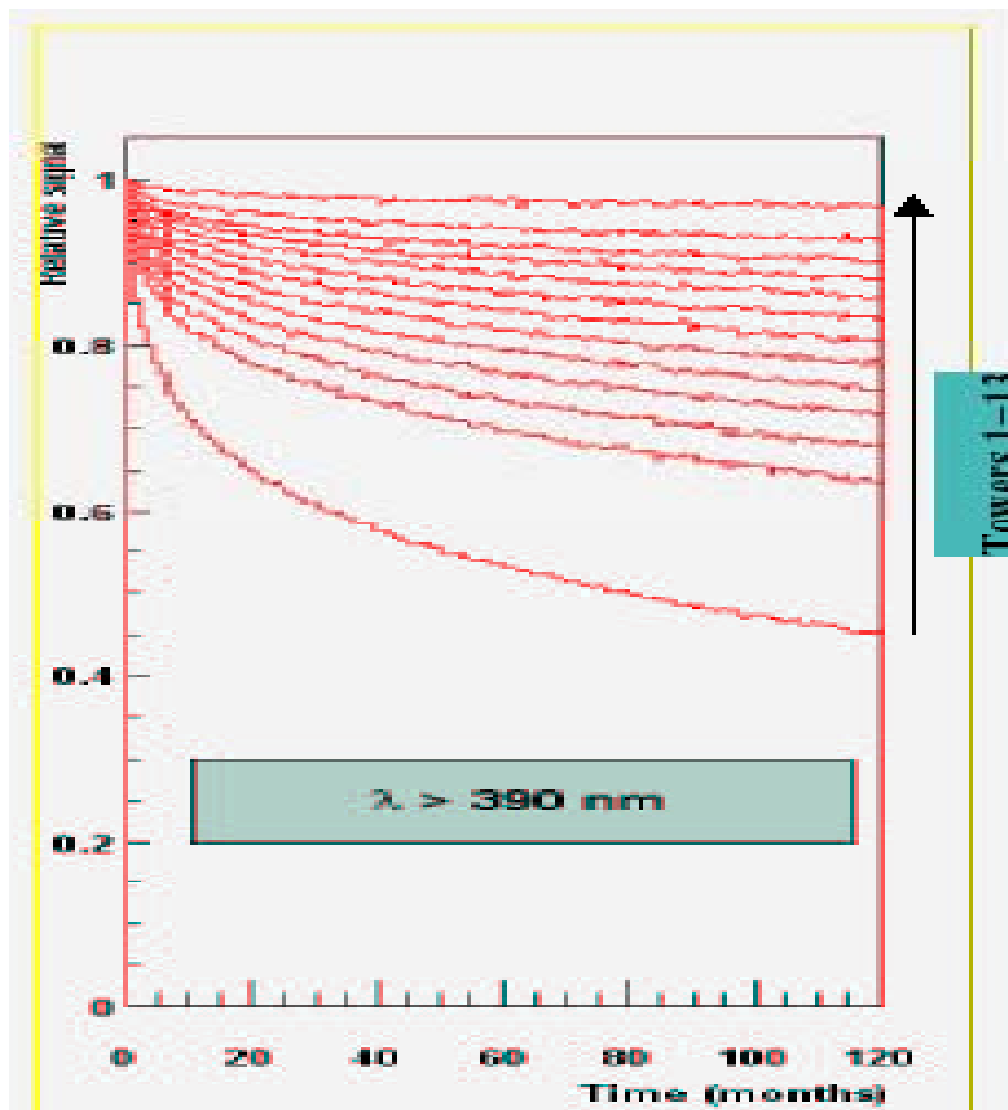


# CMS HCALS





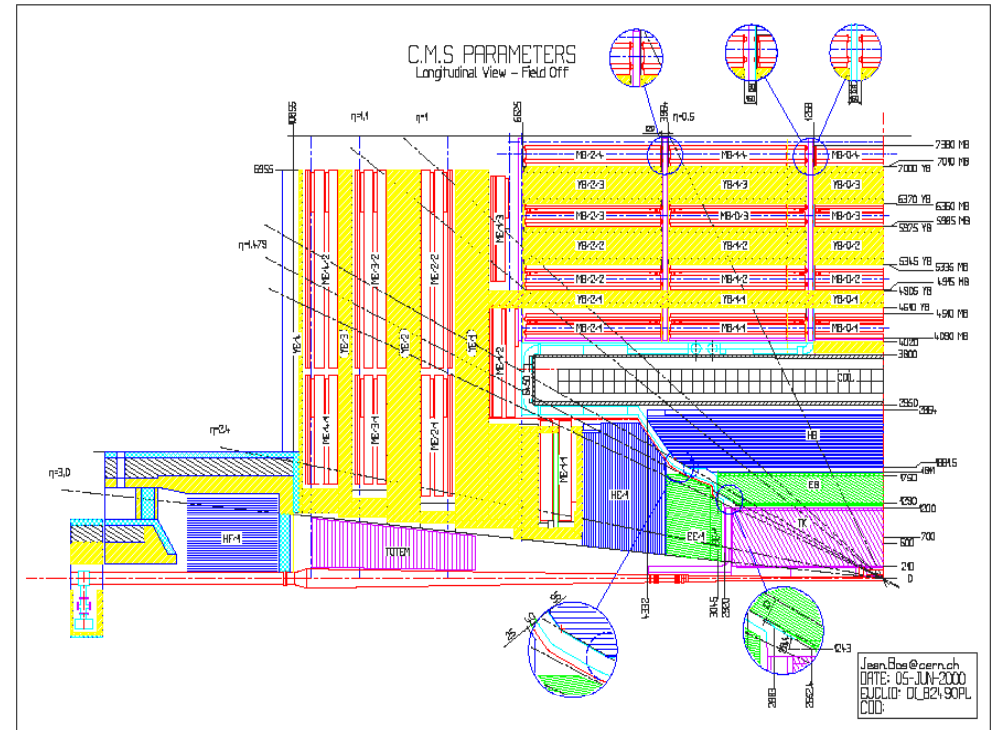
# HF Damage



Tower 1 loses 60% of light during LHC, down to 4% of original after 10 years of SLHC. Tower 2 down to 23% after 10 years of SLHC. SLHC “kills” a few high eta towers.

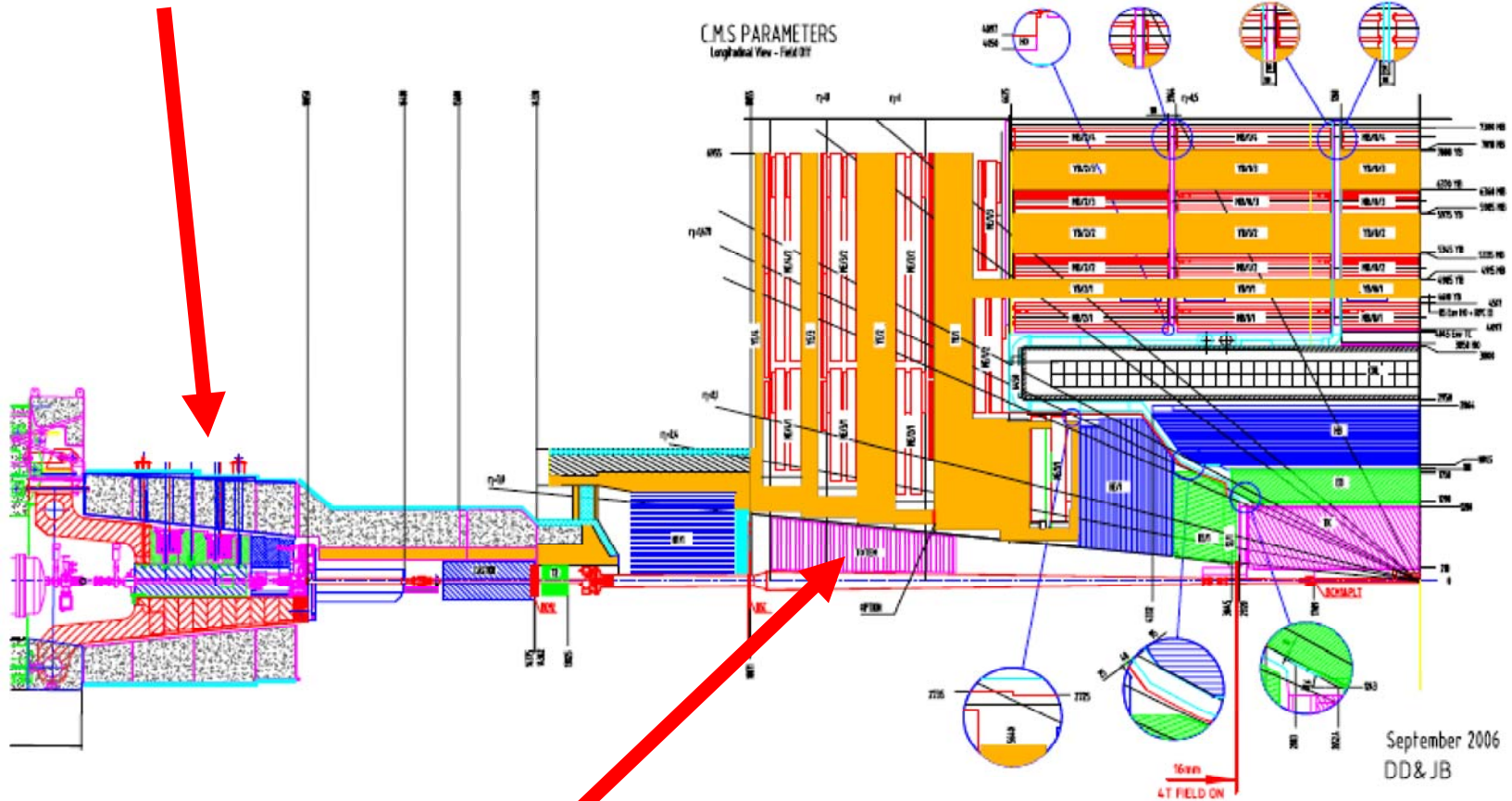
# Calorimeters/Muons

- ECAL
  - Crystal calorimeter electronics designed to operate in SLHC conditions
  - VPT in Endcap and Endcap crystals themselves may darken at SLHC
    - Very difficult to replace
- HCAL
  - HF may be blocked by potential changes to the interaction region
  - This has a direct impact mainly in the case of looking for WW scattering
- Both Calorimeters suffer degraded resolution at SLHC
  - affects electron ID, Jet resolutions
- MUON
  - system front end electronics look fairly robust at SLHC
    - Cathode Strip Chambers/RPC Forward : Drift Tubes /RPC Barrel
  - Trigger electronics for the muon systems would most likely need to be replaced/updated
    - Some Electronics is “less” radiation hard (FPGA)
    - Coping with higher rate/different bunch crossing frequency
    - May have to limit coverage in  $\eta$  ( $\eta > 2$ ) due to radiation splash
      - This effect will be known better after first data taking, potential additional cost of chamber replacement



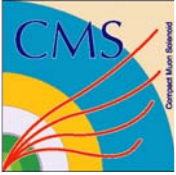
# CMS IP Upgrade

Triplet moves closer to IP



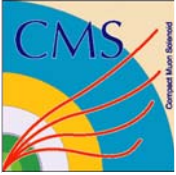
Dipole inside end disks





# CMS R&D Proposals

- SLHC Upgrade Steering Group formed in 2005
  - [http://cmsdoc.cern.ch/cms/electronics/html/elec\\_web/common/slhc.html](http://cmsdoc.cern.ch/cms/electronics/html/elec_web/common/slhc.html)
- This group is charged with
  - Recommending R&D proposals for approval to CMS MB/CB
  - Planning SLHC workshops
  - Outreach to collaboration
  - Interaction/Co-ordination with Machine and ATLAS on SLHC matters
  - Regular Reporting to Management Board/CB
- R&D Proposals get a stamp of CMS approval before going to funding agencies
  - Reviewed by SG

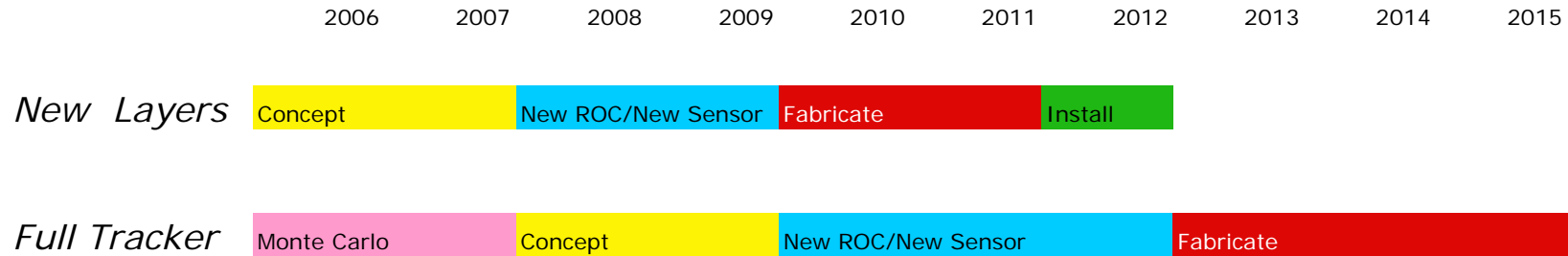


# CMS SLHC Workshops

- Four workshops held over the past 3 years
  - <http://agenda.cern.ch/fullAgenda.php?ida=a036368>
  - <http://agenda.cern.ch/fullAgenda.php?ida=a041379>
  - <http://indico.cern.ch/conferenceDisplay.py?confId=a053123>
  - <http://indico.cern.ch/conferenceDisplay.py?confId=a06865>
- Establish requirements for upgrades of sub-detectors
- Identify R&D needed for upgrades
- Prepare potential upgrade concepts
- Additional workshops within tracker community
  - <http://indico.cern.ch/conferenceDisplay.py?confId=6904>
  - <http://indico.cern.ch/conferenceDisplay.py?confId=12094>



# Roadmap for tracker/trigger upgrades

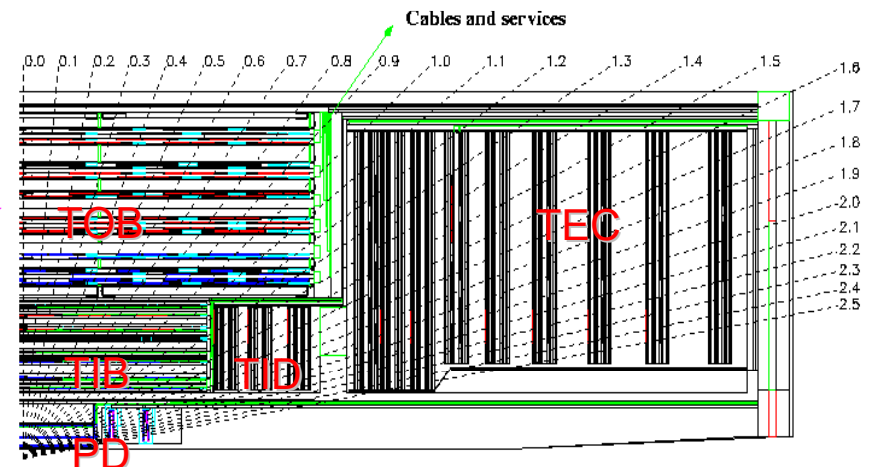
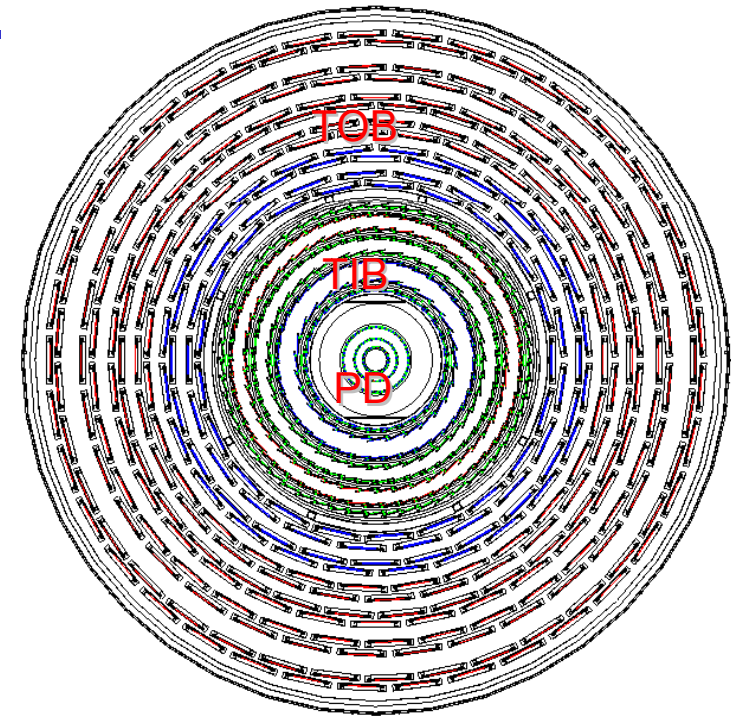


- Within 5 years of LHC start
  - New layers within the volume of the current Pixel tracker which incorporate some tracking information for Level 1 Trigger
    - Room within the current envelope for additional layers
    - Possibly replace existing layers
  - “Pathfinder” for full tracking trigger
    - Proof of principle, prototype for larger system
  - Elements of new Level 1 trigger
    - Utilize the new tracking information
    - Correlation between systems
- Upgrade to full new tracker system by SLHC (8-10 years from LHC Startup)
  - Includes full upgrade to trigger system



# Ideas on a new tracker concept?

- Strawman - A much larger pixel tracker, some triggering layers, more segmented strips
  - 10 cm layer with *current* pixels (500 Chf/cm<sup>2</sup>)
    - Around 1m<sup>2</sup>
  - 20/40/60 cm layers with bigger pixels (100 Chf/cm<sup>2</sup>)
    - around 25 m<sup>2</sup>
    - 25 MChf
  - Outer layers long pixels/short strips (30 Chf/cm<sup>2</sup>)
    - Around 170 m<sup>2</sup>
    - 50 MChf
  - Some triggering layers.
    - 1 layer for Pt cut only or 2 layers to measure Pt
    - Or perhaps full scale hardware pattern recognition?
- This is the at the limit of affordability - How much can we re-use?
  - Can we use the TOB mechanical structures (a copy at least)
  - Can we re-use services
  - Re-use of some of the TOB - at least the concept if not the actual modules







# SLHC R&D:Next steps

- Expression of Interest
  - Reasonably brief document (40 pages)
  - Brief case for upgrade
  - Outlines scope of upgrade work
    - What detectors/Timescale
  - Submitted to LHCC March 2007
  - Prepare funding agencies
- Letter of Intent
  - A larger document
  - More complete physics case
  - Includes organization and rough costings of detector work
    - Including how CMS will organize the effort
  - Submitted to LHCC
    - Allow funding agencies to “release” funding
  - Target Summer 2008



CERN/LHCC 2006-xxx  
CMS EOI xxx  
dd month 2006



**CMS**  
Expression of Interest in the  
**SLHC**

CMS xxx Projects ... update below !!!		
CMS Spokesperson	Michel Della Negra, CERN	Michel.Della.Negra@cern.ch
CMS Technical Coordinator	Austin Ball, CERN	Austin.Ball@cern.ch
CMS Collaboration Head Chair	Lorenzo Foa, Pisa	Lorenzo.Foa@cern.ch



# CMS Detector Replacements

Inner Tracker	30 MChf
Outer Tracker	90 MChf
Level 1 Trigger	20 MChf
DAQ	10 MChf
Other Front Ends	10 MChf
Infrastructure	15 MChf
Total	175 MChf

Across collaboration  
~ 900 FTE

Materials Cost for  
Collaboration (CORE)



# Some of the Identified R&D areas

- Pixel technology
  - Hybrid - cheaper bonding
  - MAPS/SOI - need an answer now if it can be used
- Geometry
  - How many different sensors
  - Layout of inner/outer pixels
- Triggering layers
  - How many/Where
- Readout
  - Current ROC to 130 nm
  - New ROC to push Col hit info for stacks
  - Correlator Chip
- Link and Control technology
  - GBT?
  - Optical Links
    - Re-use of part of the plant?
- Radiation tolerance and robustness of 130nm/90nm
- Technology for a very inner layer
  - Different sensor
- Power/Material
  - DC-DC/Serial power



# Conclusions

- CMS at SLHC Upgrade largely driven by tracker requirements
  - Higher granularity
  - Potentially substantially larger pixel detector
  - We may also need to understand how to form tracks with these detectors at 40 (20) MHz as input to the Level 1
- Trigger system will need replacement
- R&D required is substantial
  - Needs to start now
  - Needs to be focused
    - Important to converge on tracker design requirements
      - Need input from simulation/machine studies
- This workshop offers an opportunity to identify areas where we can collaborate while R&D is still in an early stage